

Report from the Technical Board



Roman Pöschl LAL Orsay

From FNAL to UTA

Developments since CALICE TB Review Meeting at FNAL

CALICE Collaboration Meeting Arlington/TX March 2010

The Corner Stones

 Concluding the "Physics Prototype Phase" - Phase CALICE I - with completion of the US-DHCAL and combined test beam at FNAL with the SiW Ecal and TCMT

Roadmap issue of TB Review meeting

NEW: Physics Prototype of W-HCAL

- Preparing/Realising the "Technological prototype phase" - Phase CALICE II

Several prototypes moving towards construction phase

- SiW Ecal

New: Common effort with ScintEcal

- SDHCAL-GRPC
- SDHCAL with Micromegas
- AHCAL
- Generic R&D on DECAL/MAPS

Towards the US-DHCAL

- US-DHCAL needs to construct 1 m² layers with new components and newly developed manufacturing techniques
- Large GRPC including resistive painting Reliable painting still seems to be an issue!
- New Chip DCAL III Mass test successful all Chips at Hand
- New FE Boards adapted to needs of 1m² layers
 In Test phase before mass production, 120 FE needed
- Mastering the manufacturing process (Building of frames, Gluing of different components Good Progress: infrastructure settled for RPC assembly, trained staff Cassette integrated into Calice stack at FNAL
- Integration of DAQ and s/w into existing calice scheme
 Intensively discussed Modifs to trigger and timing module to handle event busy flag from CALICE DAQ
- First layer not yet realised but gets in sight
- TB asked for a time plan on the mass production of 120 Chambers to make up the 40 Layers needed

 Current goal is to have 40 layers by end of April. Challenging!!!!
- TB strongly recommended a 1st Layer integration

 Test will be done after April 1. Requires Paul, DESY colleagues and maybe R.P. an site at FNAI
- Integration of the GEM structures fell a bit out of focus

Combined test beam – Detector Status and Constraints

- SiW Ecal

Investigation of reason for dead areas during summer09 on LLR test bench.

Dead zones not reproducible)

SiW Ecal is ready at any time to be put back into the test beam

N.B.: In order to save travel money test beam have to be conducted with minimal man power on site

Shifts via remote control room -> to be established in France

Definition of beam test program would however need input from SiWEcal <-> AHCAL combined tests

- TCMT

- Currently no funding for TCMT available
- Detector would be run by DESY collegues with local support by NIU TCMT is however operational
- Beamline/Trigger
 - Commissioning by DESY with support from other testbeam participants
- Two important issues to be mentioned
 - 1) The stage at FNAL is unused since June 2009
 - Due to customs regulations the stage has to be transported back to Europe by April 2011

First Steps on the Roadmap – Towards the Technological Prototypes

The aim is to build and operate prototypes as close as possible to what we would like to have for the ILC

- How well do the ongoing projects meet this requirement?
- What steps are needed to complete the prototypes
- Where can we act as a collaboration?
- Roadmap for technological prototype as issue of FNAL meeting
- Agreed by Steering Board at Collaboration Meeting at Lyon TB Review Document can found under

http://flc.web.lal.in2p3.fr/poeschl/tb-review.doc

Timelines for (HCAL) Detectors - Roadmap

DHCAL

1m² "Phase"

Production Phase

Testbeam Phase



Operation pf 1st 1m² in **Testbeam Decision of Chips** in Testbeam Check out of **Electronics** Final Layout of Mechanics First power pulsing

Towards the full scale prototype Production and system Check How many layers of each species?

Final DAO Commissioning During that time we

need to develop a working interface online - offline

Large Scale Testbeam Technological Program to be defined

Physics Program to be defined Data taking rate

O(100Hz) from VFE

SiW Ecal enters the game

Issues for continous operation

1/7/09

1/7/10

1/7/11

AHCAI Prototype System

Full Layer Phase

Towards Full Module



SiPM, SPIROC et al.

First power pulsing?

Vertical Stacking to allow small physics running with electrons

Running in ILC mode?

Final DAQ Commissioning

Mechanics test Production of full module

SDHCAL GRPC and Micromegas – Towards a 1m³ protoype

GRPC

Micromegas

- successful tests with 1m²
 prototypes in 2009
 Tests with HRI, HRII
- Chamber construction under control
- Very interesting results with semi conductive glass
 High Rates ~100kHz/cm²
- 2010 continuation of 1m² tests Power pulsing on the agenda
- Step from USB based DAQ to "EUDET DAQ"

- Less successful year 2009 in terms of beam tests
 DAQ Problems, Spark problems
- Beam tests for 2010 with 1m² planned
 - DIRAC or HARDROC?
- Mechanics for Chamber construction under control
- Flexibility for installation in existing or new Calice stack

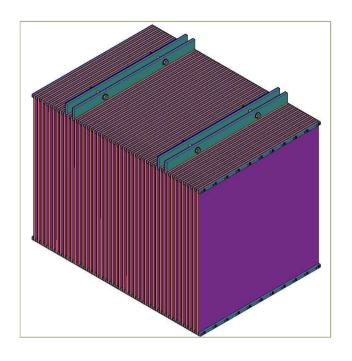
Close collaboration at DAQ Level – DIF and beyond

Number of layers to be produced in 2010 for each variant of sensitive material left to committees organised in France

(Distribution of existing funding for french contribution to SDHCAL) Consultance by Technical Board if desired

SDHCAL - Self-Supporting Structure

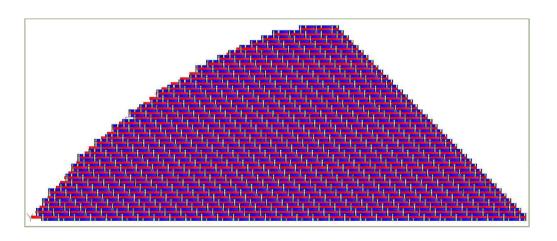
In agreement with recommendation of TB Review Document

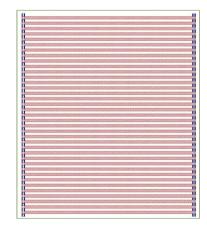


Mechanical structure, parameters:

- 44 slots to can implement 44 MICROMEGAS or GRPCs.
- Structure compose of only 2 different kinds of pieces.
 Attached between by M8 screws, 11+11 bolts by layer.
- plus base support pieces and the manipulation fixations (By 2 bolts of M20), only can be fixed elements to the bar pieces.

Extrapolation of the m³ module philosophy for the ILD (One Proposal!!!)





AHCAL – Towards a Technological Prototype

Cassette

Front-End ASICs

(144 channels)

absorber structure (half-sector)

DAQ interface boards DIF. CALIB. POWER

Sector Connecting Plates (10cm)

on Central Interface Board

HCAL Base Unit (HBU)

Mech. structures

horizontal

vertical

Status and Planning:

Side-Module Interface Board

110 CT

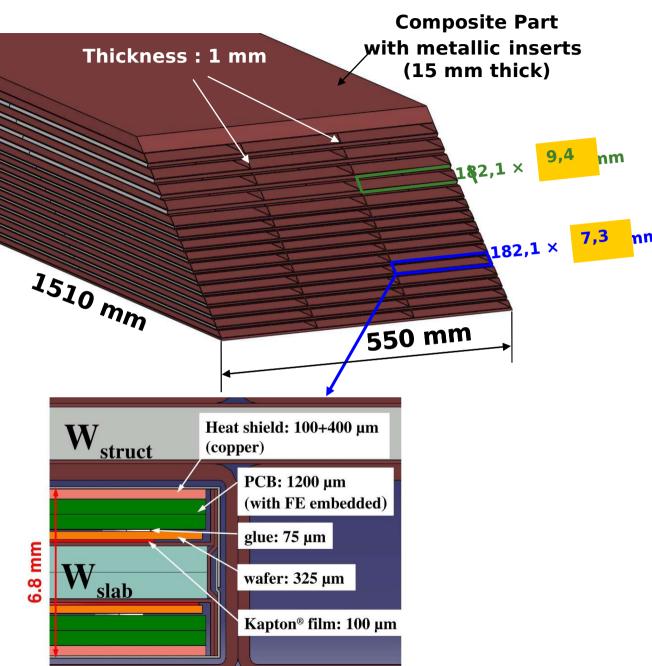
HCAL ECAL Cabling

- First HCAL HBU in DESY Testbeam
- Full slab end of 2010
- "Vertical Test" in 2011 Stack will be equipped vertically for tests with electrons (DESY?)

W-HCAL

- Hadronic Calorimeter using Tungsten Absorber Driven by High energy needs
- Will use sensitive parts from existing analogue (steel) Hcal and Micromegas
- So far no monitoring in Calice-TB
 Plans only presented at Collaboration Meeting
 Regular reports to calice-tb will start after UTA Meeting
- Plan for considerable testbeam in September 2010 at CERN PS

SiW Ecal

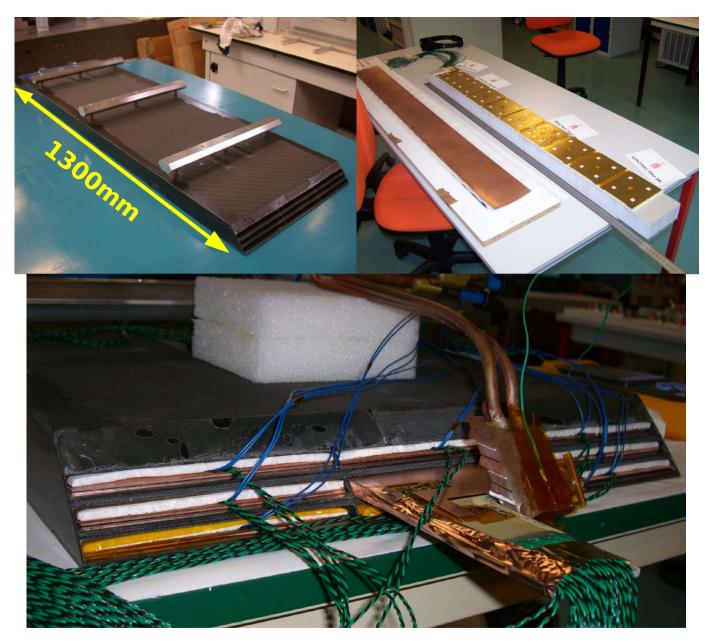


Prototype of VFE



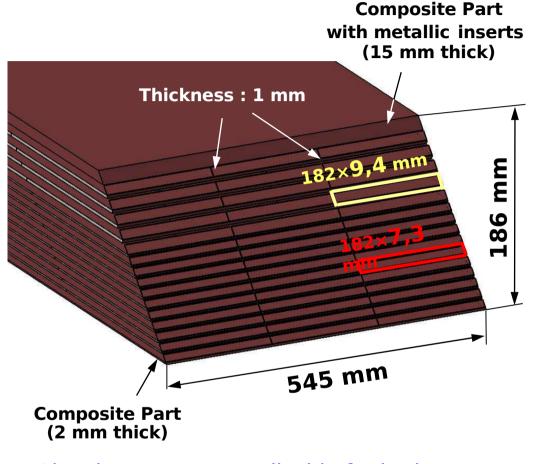
- Progress in VFE Electronics
 SKIROC Chip sent(?) to foundry
 Corean partners for FEV8 board
 Tests with SPIROC
 and FEV7 (ASU by end of 2010)
- Progress in DAQ.
 Communication to DIF via LDA
 Next step communication with actual VFE
- SiW Ecal Layers mid 2011?
- Testbeam late 2011 early 2012 should plan for progressive tests

Demonstrator 2009

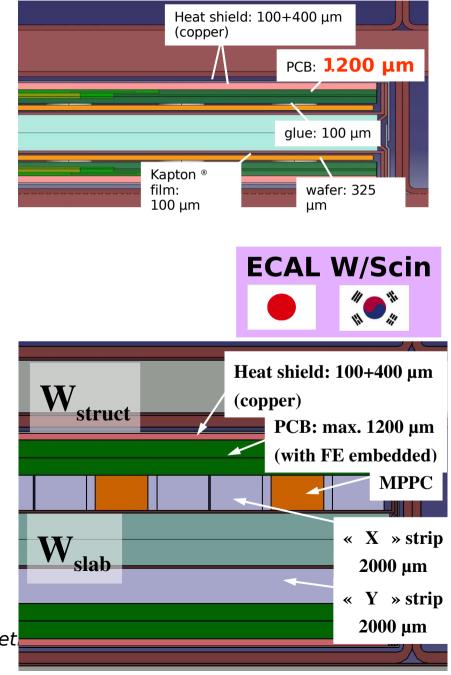


- Detector module realised (from mechanical point of view)
- Demonstrator subject to a thermal test

Collaboration SiW-Scint Ecal Initiated by TB-Review Meeting



- Alveolar structure applicable for both Ecal proposals
- Details on integration are currently worked out.
 - Communication SiW Ecal-ScintEcal-DESY
- Schedule to be precised in coming months



CALICE Collaboration Meet

Reducing the Cost of the (ILC) Ecal

The CALICE TB endorses to use the years 2010 and 2011 for the R&D of wafers at lower prices and extensive studies of the Si market. This is also vital for the realisation of a SiW calorimeter for an ILC detector.

- Hybrid Ecal might be one solution to master cost of Ecal w/o performance penalty
- Still silicon cost need to be controlled
 - Forging closer contacts with industry LETI France Hamamatsu Japan

More details by JCB

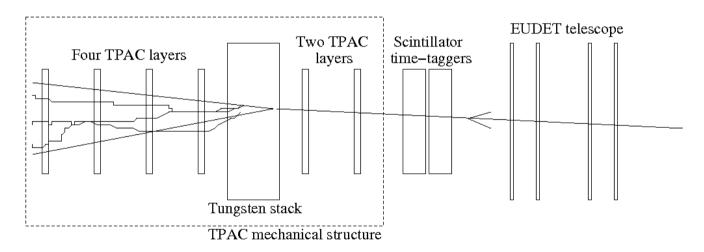
MAPS – DECAL - Spider

Since TB Review DECAL is regularly on the agenda of CALICE TB

SPIDER

- Silicon Pixel Detector R&D
- Remnants of CALICE-UK DECAL group and LCFI
- "Generic" pixel detectors for future colliders
- Struggle a lot with disastrous funding situation in UK

DESY Testbeam March 2010



- Efficiency for different sensor variants
- Shower densities in <u>electromagnetic</u> showers
- Program after April 2010 entirely uncertain



DAQ system overview

(Detector Unit : ASICs)

DIF: Detector InterFace connects generic

DAQ and services

LDA: Link/Data Aggregator fans out/in

DIFs and drives links to ODR

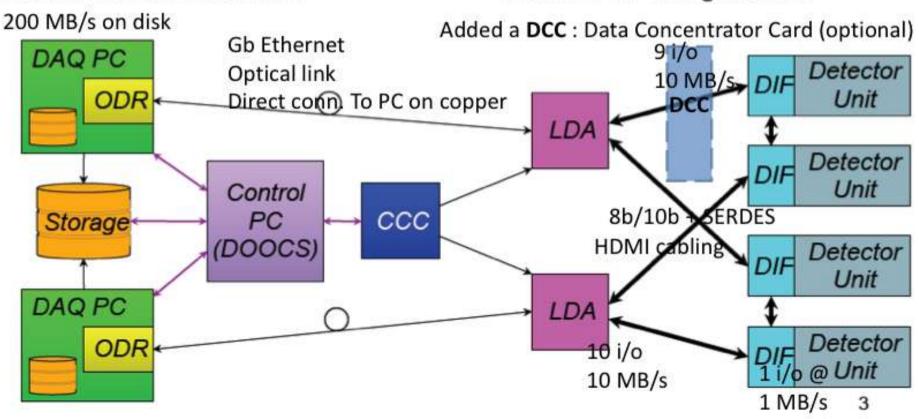
ODR: Off-Detector Receiver is PC

interface

CCC: Clock and Control Card fans ou

to ODRs (or LDAs)

Control PC: Using DOOCS



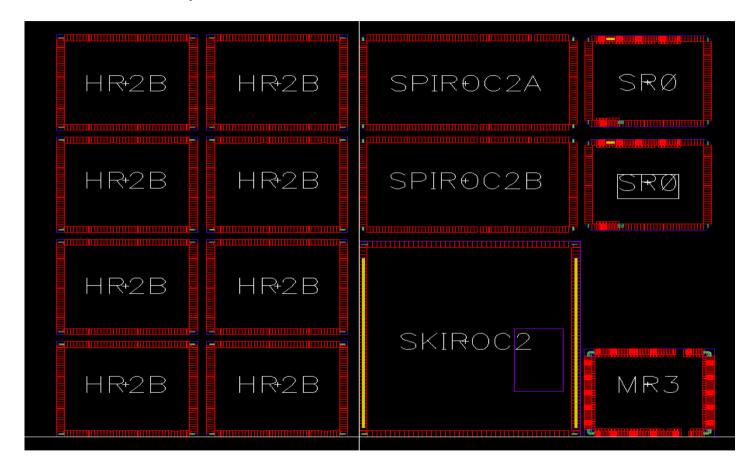
Status of DAQ for Technological Prototypes

- Hardware provided by UK groups Now start of operation
 So far it looks alright, but devil is in the details
 Drop out of UK groups essentially caught by french groups
 Transfer of information works smoothly (still clearly deplorable situation)
 Remarkable effort of UK groups to remain in business
- SDHCAL DAQ: first working chain running in may/early summer of 2010
 Stress tests during summer early autumn 2010.
 1m² prototypes of the SDHCAL are read out by USB based DAQs need to complete step towards Ethernet/HDMI DAQ
- New Groups for DAQ Tasks?
 Though impressive progress, SiW Ecal is at risk (depends on one person)
 Slow control for Ecal (and other prototypes)?
- Which s/w frame for DAQ piloting to choose?
 DOOCS. XDAQ, Tango?

Decisions to be taken until Easter!!!!

Status of FEE

- Production Run March 2010
- Reticle: 22 x 18 mm², 50 reticles per wafer
- 25 wafers produced,



- SKIROC for Ecal is integrated

=> Back in phase with other chips <-> Compliant with TB Review More details in Electronics Session

CALICE Software

- New Software Coordinator <u>Angela Lucaci-Timoce</u>
Proven already to be very competent

- Contacts for subdetectors (CALICE I):

SiW Ecal: K. Krastev, R.Poeschl

ScintEcal: Cotera (?)
AHCAL: Angela herself

(S)DHCALS: ??? (Fate of task force initiated by Niels)

TCMT: K.Francis?

Tracking: P. Dauncey, D. Jeans (?)

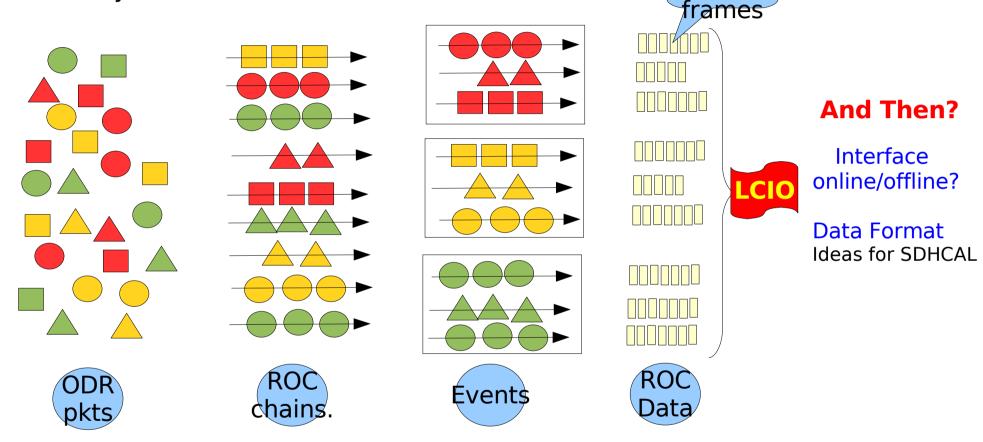
Simulation/Mokka: G. Musat

- Data Processing: Support by A. Kaplan, N.Feege, L. Weuste and S. Lu Lack of man power for mass production Data processing on request
- CALICE s/w needs to be put on broader basis
 Efficient s/w group is essential for publishing physics results

Towards s/w for Technological Prototypes

1 ROC "f"

- Readout reassembly simulation
 - Uses SystemC + low-level routineS



Scheme by D.Decotigny (LLR)

Needs tight communication between DAQ team, CALICE Software Team and ILC Coresoftware Team

Considerable Task for 2010

Testbeam planning for 2010

CALICE Requests for 2010 to FNAL

No dedicated request or MOU so far Further steps depend largely on readiness of DHCAL Phys. Prototype

CALICE Requests for 2010 to CERN

GRPC	SPS 2 weeks July and November PS 2 weeks May	Test of 1m ² Chambers	H2(Magnet)/H4/H6 T9 beamline
Mmegas	2 weeks June/July	Test of 1m ² Chambers	H2/H4 beamline
W-Hcal	PS 2 weeks 4 th quarter 2010	Hadron Calo 1m³, 1 ton??	T9 beamline
(Spider	June/July (preferred)	Pixel Ecal Calo 30x30x30cm³	H6B (EUDET Tel.!))

- Not entirely happy with preliminary CERN response CERN beamlines are very crowded!!!

- 2 main issues

- Solve situation for 2010 quickly
- Prepare planning for 2011 and beyond now!!!

 Tight communication with CERN on CALICE/LC needs to/about to be established

Topic at today's TB Meeting

Testbeam Planning beyond 2010

Table published in DESY-PRC Report (also arXiv: 1003.1394 phys.ins-det, hep-ex)

Project	2010/1	2010/2	2011/1	2011/2	2012/1	2012/2
Phys. Prot. Si-W ECAL/DCHAL/TCMT	xx	XX	XX	-	-	-
Phys. Prot. W ECAL / W HCAL / TCMT		x	x	XX	XX	-
Tech. Prot. DHCAL	x	x	xx	XX	XX	xx
Tech. Prot. AHCAL	x	x	x	x	XX	xx
Tech. Prot. Si-W ECAL	-	x	x	XX	XX	xx
Phys. Prot. DECAL	X	x	x	x	x	x
Tech. Prot. Sc-W ECAL	-	-	-	-	-	x

- No Activity
- x Small Activity
- xx Large Scale Testbeam
- Large Scale 2011/1 2012/2, SDHCAL/AHCAL+ECAL at CERN (most likely)
 Needs several weeks/months steady occupation of beam line
 Table does not take W-HCAL into account (also large scale TB)
- Other LC Detector Components
 TPC do also plan large hadron testbeams, preferrably also at CERN
- Need good coordination among ourselves, with other LC projects and facility managers (not only CERN).
- Key issue in LCTW09 document and at today's TB Board

Summary and Conclusion

- Landscape is very heterogeneous

8 different Technologies (Absorber or Sensitive Medium)
Up to six large scale prototypes which will be employed
Yet, nice examples for collaboration in R&D beyond "boundaries"
However, also counter examples

- Many items addressed at the TB Review meeting are transformed into action
- TB will continue to monitor all efforts and streamline activities
- TB will be in first line to realise longer term planning
 - Availability of Testbeam lines
 - All beam test efforts should be launched via TB (or at least TB needs to be informed)
- TB will support steps towards DBD
 - Priority list
 - Prepare judgement on maturity of detector technology
 Need charge by steering board on exact measures

It should be CALICE who decides which technology is mature and which is not